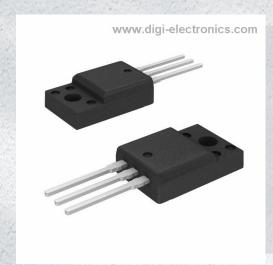


FCPF600N60Z Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number FCPF600N60Z-DG

Manufacturer onsemi

Manufacturer Product Number FCPF600N60Z

Description MOSFET N-CH 600V 7.4A TO220F

Detailed Description N-Channel 600 V 7.4A (Tc) 89W (Tc) Through Hole T

O-220F-3



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FCPF600N60Z	onsemi
Series:	Product Status:
SuperFET® II	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
600 V	7.4A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
10V	600mOhm @ 3.7A, 10V
Vgs(th) (Max) @ Id:	Gate Charge (Qg) (Max) @ Vgs:
3.5V @ 250µA	26 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	1120 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	89W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Through Hole
Supplier Device Package:	Package / Case:
TO-220F-3	TO-220-3 Full Pack
Base Product Number:	
FCPF600	

Environmental & Export classification

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	Not Applicable
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	



MOSFET - N-Channel, SUPERFET[®] II

600 V, 7.4 A, 600 mΩ

FCP600N60Z, FCPF600N60Z

Description

SUPERFET II MOSFET is onsemi's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

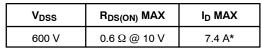
Features

- 650 V @ $T_J = 150$ °C
- Typ. $R_{DS(on)} = 510 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 20 nC)
- Applications

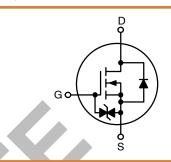
 LCD/LED/PDP TV and Monitor Lighting

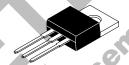
 Solar Inverter

 AC-DC Power Supply • Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 74 pF)



^{*}Drain current limited by maximum junction temperature.



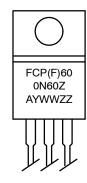


TO-220-3LD CASE 340AT



220 Fullpack, 3-Lead / TO-220F-3SG CASE 221AT

MARKING DIAGRAM



FCP(F)600N60Z= Device Code

= Assembly Location YWW = Date Code (Year & Week)

ΖZ = Assembly Lot

ORDERING INFORMATION

Device	Package	Shipping
FCP600N60Z	TO-220-3LD	800 Units / Tube
FCPF600N60Z	TO-220 Fullpack	1000 Units / Tube

MOSFET MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Symbol		Parameter	FCP600N60Z	FCPF600N60Z	Unit
V_{DSS}	Drain to Source Voltage		6	600	
V_{GSS}	Gate to Source Voltage	-DC	±	20	V
		-AC (f > 1 Hz)	±	30	
I _D	Drain Current	- Continuous (T _C = 25°C)	7.4	7.4*	Α
		– Continuous (T _C = 100°C)	4.7	4.7*	
I _{DM}	Drain Current	- Pulsed (Note 1)	22.2	22.2*	Α
E _{AS}	Single Pulsed Avalanche	Energy (Note 2)	135		mJ
I _{AR}	Avalanche Current (Note 1)		. 1	1.5	
E _{AR}	Repetitive Avalanche Energy (Note 1)		0.	0.89	
dv/dt	MOSFET dv/dt		100		V/ns
	Peak Diode Recovery dv/	dt (Note 3)	2	20	
P_{D}	Power Dissipation	(T _C = 25°C)	89	28	W
		-Derate above 25°C	0.71	0.22	W/°C
T _J , T _{STG}	Operating and Storage Te	mperature Range	-55 to	o +150	°C
T_L	Maximum Lead Temperat 1/8" from Case for 5 Second		4, 3	000	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	FCP600N60Z	FCPF600N60Z	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.4	4.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	
	O HISE COLLAIN REPRESENTATION			

^{*}Drain current limited by maximum junction temperature.

^{1.} Repetitive rating: pulse-width limited by maximum junction temperature.

^{2.} $I_{AS} = 1.5 \text{ A}$, $V_{DD} = 50 \text{ V}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \le 3.7 \text{ A}$, di/dt $\le 200 \text{ A}/\mu\text{s}$, $V_{DD} \le BV_{DSS}$, starting $T_J = 25^{\circ}\text{C}$.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V _{GS} = 0 V, I _D = 10 mA, T _J = 25°C	600	_	_	V
		V _{GS} = 0 V, I _D = 10 mA, T _J = 150°C	650	_	-	
ΔBV_{DSS}	Breakdown Voltage Temperature	I _D = 10 mA, referenced to 25°C	-	0.67	-	V/°C
ΔT_{J}	Coefficient					
BV _{DS}	Drain to Source Avalanche Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 7.4 \text{ A}$	-	700	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 600 V, V _{GS} = 0 V	-	_	1	μΑ
		V _{DS} = 480 V, T _C = 125°C	-	1.32	_	
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	<u></u> -	_	±10	μΑ
ON CHARA	CTERISTICS				-	-
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.5	_	3.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 3.7 A	-	0.51	0.6	Ω
9FS	Forward Transconductance	V _{DS} = 20 V, I _D = 3.7 A	-	6.7	_	S
DYNAMIC (DYNAMIC CHARACTERISTICS					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		840	1120	pF
C _{oss}	Output Capacitance			630	840	pF
C _{rss}	Reverse Transfer Capacitance		4	30	45	pF
C _{oss}	Output Capacitance	$V_{DS} = 380 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	<u> </u>	16.5	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 480 V, V _{GS} = 0 V	_	74	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, I_D = 3.7 \text{ A}, V_{GS} = 10 \text{ V}$	-	20	26	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	3.4	-	nC
Q_{gd}	Gate to Drain "Miller" Charge	CVA	-	7.5	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	2.89	=	Ω
SWITCHING	G CHARACTERISTICS	04				
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, I_D = 3.7 \text{ A}, V_{GS} = 10 \text{ V},$	-	13	36	ns
t _r	Turn-On Rise Time	$R_G = 4.7 \Omega$ (Note 4)	-	7	24	ns
t _{d(off)}	Turn-Off Delay Time		-	39	88	ns
t _f	Turn-Off Fall Time		-	9	28	ns
DRAIN-SO	URCE DIODE CHARACTERISTICS					
Is	Maximum Continuous Drain to Source Di	ode Forward Current	-	_	7.4	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	_	22.2	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 3.7 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 3.7 A,	-	200	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs	_	2.3	_	μС

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

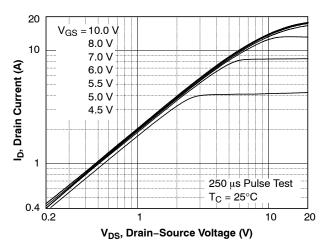


Figure 1. On-Region Characteristics

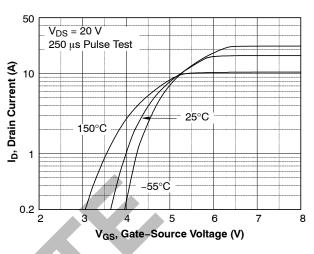


Figure 2. Transfer Characteristics

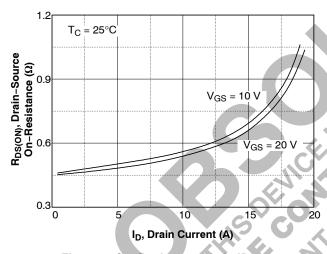


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

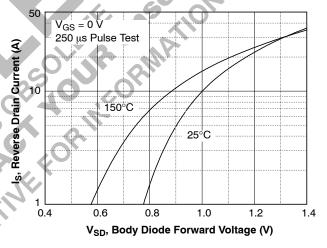


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

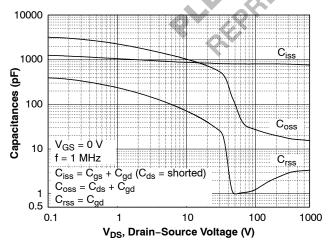


Figure 5. Capacitance Characteristics

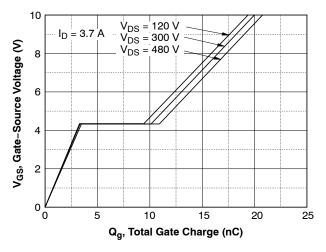


Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

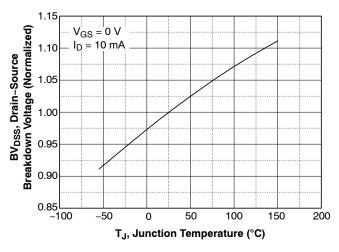


Figure 7. Breakdown Voltage Variation vs. Temperature

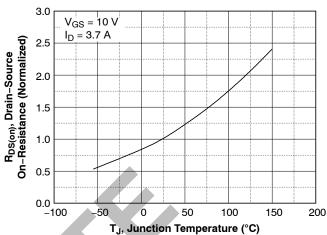


Figure 8. On–Resistance Variation vs. Temperature

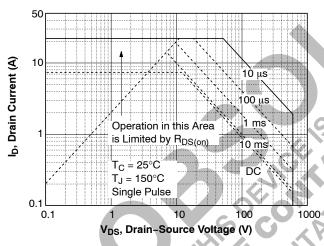


Figure 9. Maximum Safe Operating Area for FCP600N60Z

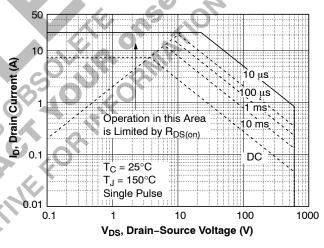


Figure 10. Maximum Safe Operating Area for FCPF600N60Z

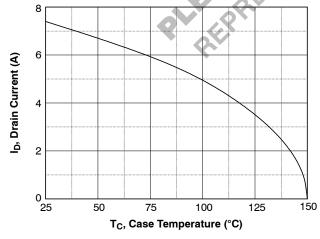


Figure 11. Maximum Drain Current vs. Case Temperature

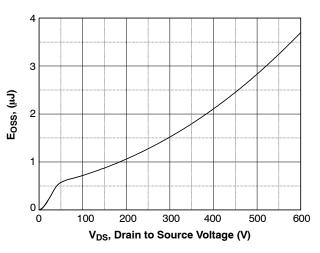


Figure 12. E_{OSS} vs. Drain to Source Voltage

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

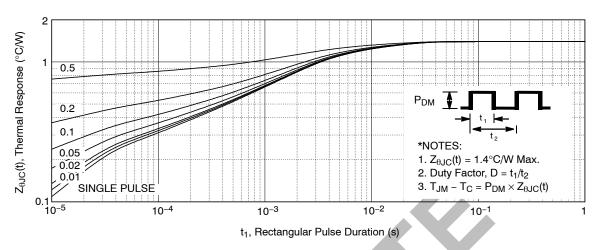
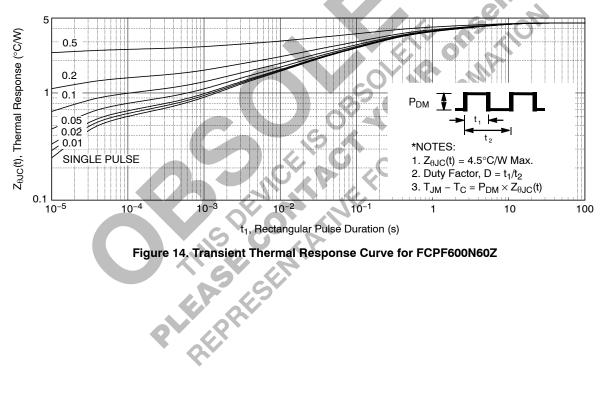


Figure 13. Transient Thermal Response Curve for FCP600N60Z



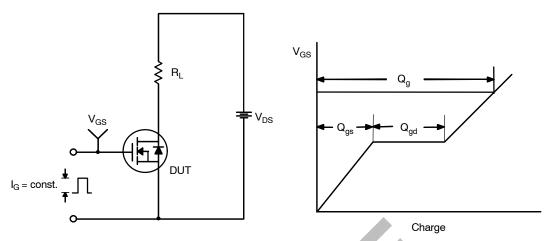


Figure 15. Gate Charge Test Circuit & Waveform

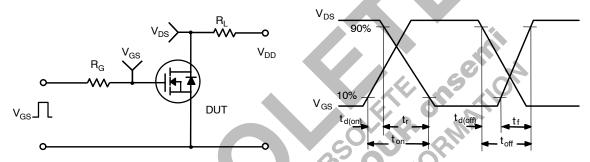


Figure 16. Resistive Switching Test Circuit & Waveforms

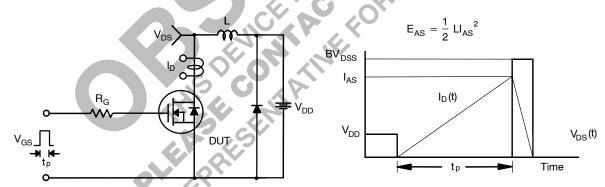


Figure 17. Unclamped Inductive Switching Test Circuit & Waveforms

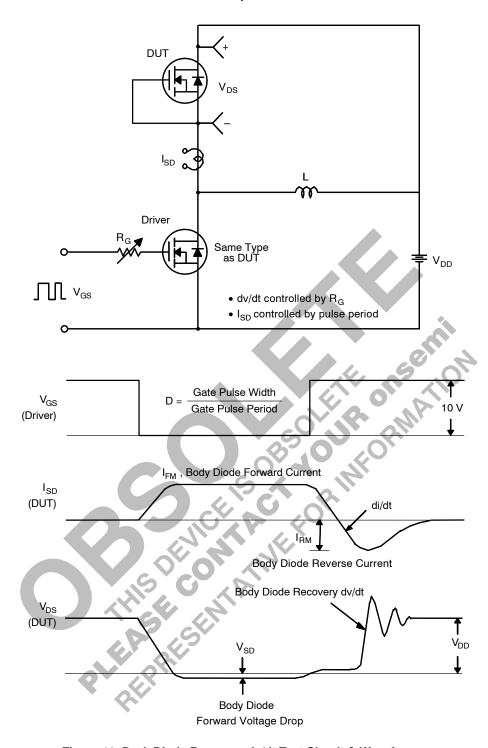


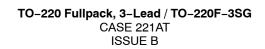
Figure 18. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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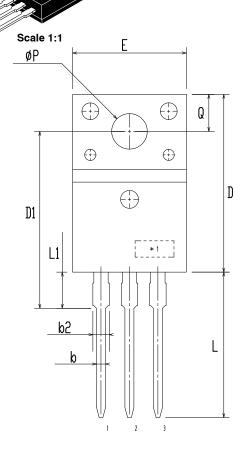


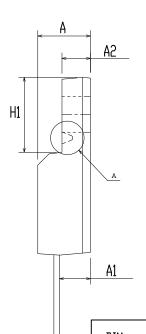
MECHANICAL CASE OUTLINE

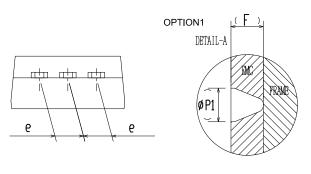
PACKAGE DIMENSIONS



DATE 19 JAN 2021







DIM	LITE	LITTILING	
ויונע	MIN	NDM	MAX
Α	4.50	4.70	4.90
A1	2.56	2.76	2.96
A2	2.34	2.54	2.74
b	0.70	0.80	0.90
b2	~	2	1.47
С	0.45	0.50	0.60
D	15.67	15.87	16.07
D1	15.60	15.80	16.00
E	9.96	10.16	10.36
е	2.34	2.54	2.74
F	~	0.84	2
H1	6.48	6.68	6.88
L	12.78	12.98	13.18
L1	3.03	3.23	3.43
ØΡ	2.98	3.18	3.38
Ø P1	~	1.00	~
Q	3,20	3.30	3.40

MILL IMITERS

NOTES:

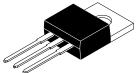
- A. DIMENSION AND TOLERANCE AS ASME Y14.5-2009
- B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUCSIONS.
- C. OPTION 1 WITH SUPPORT PIN HOLE OPTION 2 - NO SUPPORT PIN HOLE

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DESCRIPTION:	TO-220 FULLPACK, 3-LEAD / TO-220F-3SG		PAGE 1 OF 1

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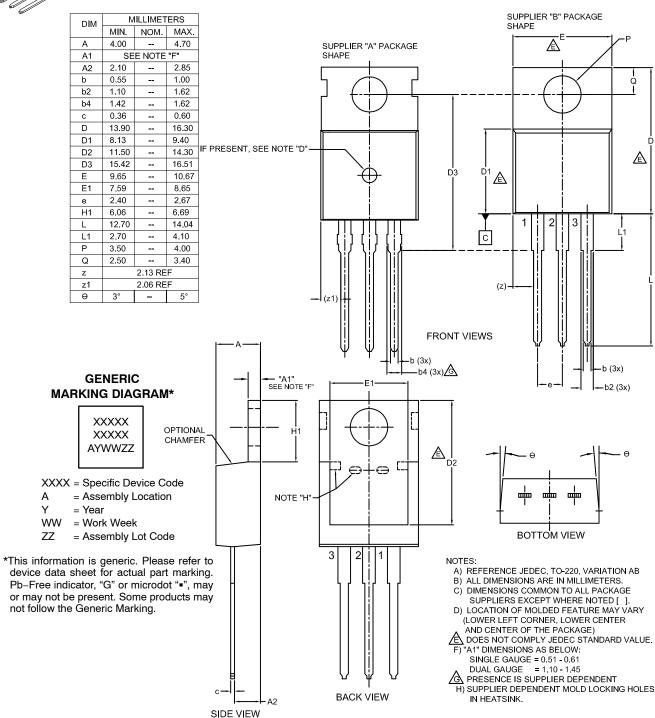


MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



TO-220-3LD CASE 340AT **ISSUE B**

DATE 08 AUG 2022



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DESCRIPTION:	TO-220-3LD		PAGE 1 OF 1

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